

# RKV605KL

# Variable Capacitance Diode for VCO

REJ03G1365-0100 Rev.1.00 Apr 05, 2006

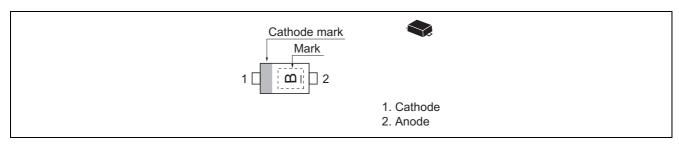
#### **Features**

- High capacitance ratio. (n = 2.02 to 2.26)
- Low series resistance. (rs =  $0.40 \Omega \text{ max}$ )
- Extremely small Flat Lead Package (EFP) is suitable for surface mount design.

### **Ordering Information**

Type No.	Laser Mark	Package Name	Package Code	
RKV605KL	В	EFP	PXSF0002ZA-A	

## **Pin Arrangement**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit
Reverse voltage	V <sub>R</sub>	10	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

#### **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R1</sub>	_	_	10	nA	V <sub>R</sub> = 10 V
	I <sub>R2</sub>	_	_	50		V <sub>R</sub> = 10 V, Ta = 60°C
Capacitance	C <sub>0.5</sub>	18.5	_	20.0	pF	V <sub>R</sub> = 0.5 V, f = 1 MHz
	C <sub>2.5</sub>	8.55	_	9.45		V <sub>R</sub> = 2.5 V, f = 1 MHz
Capacitance ratio	n	2.02	_	2.26	_	C <sub>0.5</sub> /C <sub>2.5</sub>
Series resistance	r <sub>S</sub>	_	_	0.40	Ω	V <sub>R</sub> = 1 V, f = 470 MHz

Note: For EFP package, the material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

#### **Main Characteristic**

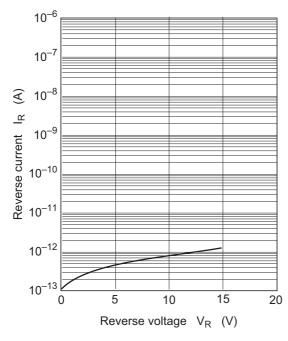
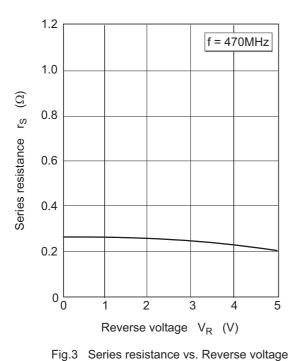


Fig.1 Reverse current vs. Reverse voltage



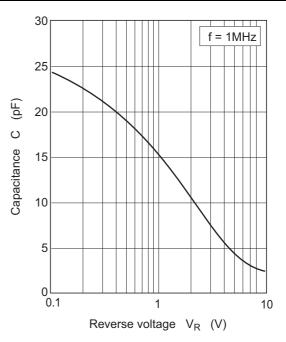
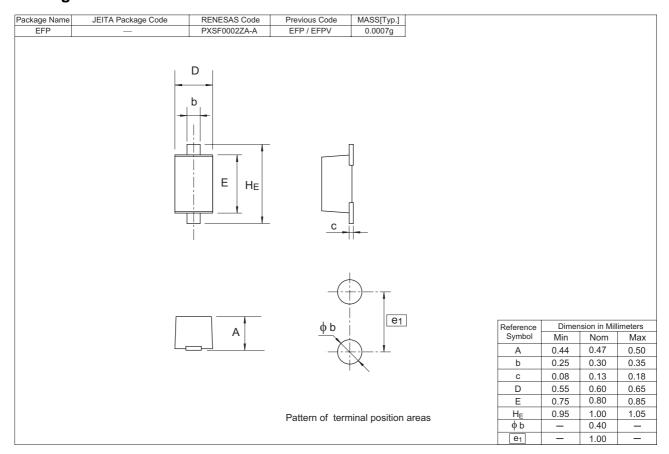


Fig.2 Capacitance vs. Reverse voltage

## **Package Dimensions**



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